ASEDCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Comp © Copyright 2005. 1 international and Par	PC. Bannockl	ourn Illinois. A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declarat the declaration e	ion of the su	ibstances v s all lower	within the manufactu level materials for v	urer listed which the	item. Note: nanufacture	if the item is an as or has engineering	ssembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					rials and N	als and Mfg Information			
upplier Information														
Company name*	Company uni	Company unique ID			Unique ID Authority				Respon	Response Date*				
onsemi							2024			2024-0	024-05-10			
Contact Name Title - Contact			zt	Phone - Contact*				Email - Contact*						
Product-Env-Stewards Product En			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			resentative			Phone - Representative*				Email ·	Email - Representative*			
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	em Number Mfr Item Nu		Number Mfr Item Name			Effective Date	Date Version Manufacturing Site			Weight*	UOM	Unit Type		
	NCP160	CP160AFCS330T2G CSP LDO 250mA, A		A, Active Disch	arge	2024-05-10	2024-05-10 CNQ		NQ	0.34614		mg	Each	
Ianufacturing Proccess Informa	tion		·									·		
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base All		Alloy	J-STD-020 MSL Rating Pe			Peak Process Body Temperature Max Time at Peak			k Tempera	Temperature Number of Reflow Cycles			
SnAgCu CU Alloy			1		260		С	30	seco	nds 3				
omments														
vel 1 - maximum time at peak temperatu	ure during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or n [F] Optionally enter the positive (+				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.2396	mg	Supplier	Silicon (Si)	7440-21-3		0.2396	mg
Protection coat	0.0089	mg		Polyimide	proprietary data		0.0089	mg
Solder Ball	0.0903	mg	Supplier	Silver (Ag)	7440-22-4		0.0023	mg
			Supplier	Tin (Sn)	7440-31-5		0.0874	mg
			Supplier	Copper (Cu)	7440-50-8		0.0005	mg
UBM Sputter	4.4E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg
Under Bump Metal	0.0069	mg	Supplier	Copper (Cu)	7440-50-8		0.0069	mg